

April 2008

# FSUSB23 — High-Speed, USB2.0 (480Mbps) Switch

#### Features

FAIRCHILD SEMICONDUCTOR

- 10µA Maximum I<sub>CCT</sub> Current over an Expanded Control
- Voltage Range: V<sub>IN</sub> = 2.6V, V<sub>CC</sub> = 3.6V)
- Lower Capacitance: C<sub>ON</sub> = 9pF Typical
- 7Ω Typical On Resistance (R<sub>ON</sub>)
- -3dB Bandwidth: > 720MHz
- Low Power Consumption: 1mA Maximum
- Wide -3db Bandwidth: > 720MHz
- Packaged in:
  - 10-Lead MicroPak<sup>™</sup> (1.6 x 2.1mm)
  - 16-Lead DQFN (2.5 x3.5mm)
- 7kV I/O to GND ESD Performance

#### **Applications**

- Cell phone, PDA, Digital Camera, and Notebook
- LCD Monitor, TV, and Set-Top Box

**Ordering Information** 

## Description

The FSUSB23 is a low-power, high-bandwidth analog switch specifically designed for high speed USB 2.0 applications. The FSUSB23 features very low quiescent current even when the control voltage is lower than the  $V_{CC}$  supply. This feature services mobile handset applications, allowing direct interface with the baseband processor general-purpose I/Os.

Typical applications involve switching in portables and consumer applications, such as cell phones, digital cameras, and notebooks with hubs or controllers. The wide bandwidth (>720MHz) of this switch exceeds the bandwidth needed to pass the third harmonic, which results in signals with minimum edge and phase distortion. Superior channel-to-channel crosstalk results in minimal interference.

Part Number	Top Mark	Operating Temperature Range	Package		
FSUSB23L10X	EZ	-40 to +85°C	10-Lead MicroPak™ 1.6 x 2.1mm, JEDEC MO-255B		
FSUSB23BQX	FSUSB23BQX USB23 -40 to +85°C 16-Terminal Depopulated Quad Very-Thin Flat Pack I Leads (DQFN), JEDEC MO-241, 2.5 x 3.5mm				
MicroPak <sup>™</sup> is a tradem	ark of Fairchild S	emiconductor Corporation.			

All packages are lead free per JEDEC: J-STD-020B standard.

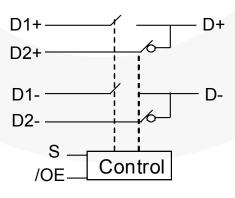
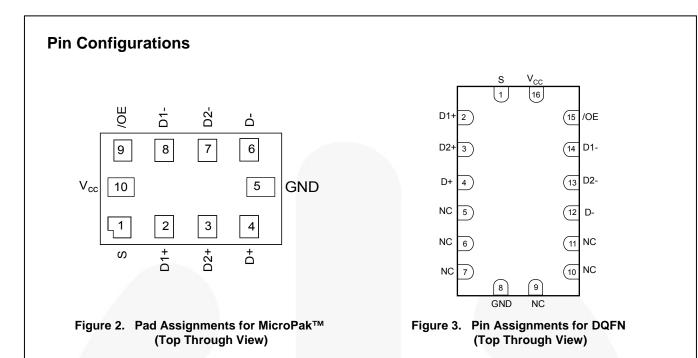


Figure 1. Analog Symbol



#### **Pin Definitions**

Pin # Micropak	Pin # DQFN	Pin Name	Pin Description
1	1	S	Switch Select
9	15	/OE	Bus Switch Enable
2, 3, 4 ,6, 7, 8	2, 3, 4, 12, 13, 14	D+, D-, Dn+, Dn-	Data Port
10	16	V <sub>cc</sub>	Supply Voltage
5	8	GND	Ground
	5, 6, 7, 9, 10, 11	NC	No Connect

#### **Truth Table**

Sel	/OE	Function
Х	HIGH	Disconnect
LOW	LOW	D+, D- = D1 <sub>n</sub>
HIGH	LOW	D+, D- = D2 <sub>n</sub>

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#### **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter		Min.	Max.	Unit
V <sub>CC</sub>	Supply Voltage	Supply Voltage		4.6	V
V <sub>SW</sub>	DC Switch Voltage <sup>(1)</sup>		-0.5	V <sub>CC</sub> + 0.5	V
V <sub>IN</sub>	DC Input Voltage <sup>(1)</sup>		-0.5	4.6	V
I <sub>IK</sub>	DC Input Diode Current		-50		mA
I <sub>OUT</sub>	DC Output Current			50	mA
T <sub>STG</sub>	Storage Temperature		-65	+150	°C
ESD	Human Body Model, JEDEC: JESD22-A114	All Pins		7	kV
ESD	Thuman bouy would, JEDEC. JESD22-AT14	I/O to GND		7	ĸν

Note:

1. The input and output negative ratings may be exceeded if the input and output diode current ratings are observed. DC switch voltage may never exceed 4.6V.

#### **Recommended Operating Conditions**

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter		Min.	Max.	Unit
Vcc	Supply Voltage		3.0	3.6	V
V <sub>CNTRL</sub>	Control Input Voltage <sup>(2)(3)</sup>		0	V <sub>CC</sub>	V
V <sub>SW</sub>	Switch Input Voltage		0	Vcc	V
T <sub>A</sub>	Operating Temperature		-40	+85	°C
$\Theta_{JA}$	Thermal Resistance Micropak			250	°C/W

Note:

2. The input and output negative voltage ratings may be exceeded if the input and output diode current ratings are observed. DC switch voltage may never exceed 4.6V.

3. The control input must be held HIGH or LOW; it must not float.

#### **DC Electrical Characteristics**

All typical values are at 25°C unless otherwise specified.

Symbol	Deremeter	Parameter Conditions		T <sub>A</sub> =- 40°C to +85°C			Units
Symbol	Parameter	Conditions	V <sub>cc</sub> (V)	Min.	Тур.	Max.	Units
VIK	Clamp Diode Voltage	I <sub>IN</sub> =-18mA	3.0			-1.2	V
V <sub>IH</sub>	Input Voltage High		3.0 to 3.6	1.2			V
V <sub>IL</sub>	Input Voltage Low		3.0 to 3.6			.50	V
I <sub>IN</sub>	Control Input Leakage	$V_{IN}$ =0V to $V_{CC}$	3.6			1	μA
l <sub>oz</sub>	Off State Leakage	$0 \leq Dn,  D1_n,  D2_n \leq V_{CC}$				1	μA
R <sub>on</sub>	Switch On Resistance <sup>(4)</sup>	V <sub>SW</sub> =0.4V, I <sub>ON</sub> =-8mA	3.0		6	9	Ω
NON	Switch Off Resistance	V <sub>SW</sub> =0.8V, I <sub>ON</sub> =-8mA	5.0		7	10	52
$\Delta R_{ON}$	Delta R <sub>ON</sub> <sup>(5)</sup>	V <sub>IN</sub> =0.4V, I <sub>ON</sub> =-8mA	3.0		0.3		Ω
R <sub>ON Flat</sub>	R <sub>ON</sub> Flatness <sup>(4)</sup>	V <sub>IN</sub> =0V-1.0V, I <sub>ON</sub> =-8mA	3.0		2.0		Ω
Icc	Quiescent Supply Current	V <sub>IN</sub> =0 or V <sub>CC</sub> , I <sub>OUT</sub> =0	3.6			1	μA
I <sub>CCT</sub>	Increase in $I_{CC}$ Current Per Control Voltage and $V_{CC}$	V <sub>IN</sub> =2.6V V <sub>CC</sub> =3.6V	3.6			10	μA

Notes:

4. Measured by the voltage drop across the  $D_n$ ,  $D1_n$ ,  $D2_n$  pins at the indicated current through the switch. On resistance is determined by the lower of the voltage on the two (HSDn or Dn ports).

5. Guaranteed by characterization.

### **AC Electrical Characteristics**

All typical values are for V<sub>CC</sub>=3.3V at 25°C unless otherwise specified.

Symbol	Parameter	Conditions	V <sub>cc</sub> (V)	T <sub>A</sub> =- 40°C to +85°C			Units
Symbol	Farameter	Conditions	V <sub>CC</sub> (V)	Min.	Тур.	Max.	Units
ton	Turn-On Time S, /OE to Output	$V_{D1n}$ , $D_{2n}$ =0.8V, R <sub>L</sub> =50 $\Omega$ , C <sub>L</sub> =10pF Figure 8	3.0 to 3.6		10	13	ns
toff	Turn-Off Time S, /OE to Output	$V_{D1n}$ , $D_{2n}$ =0.8V, RL=50 $\Omega$ , CL=10pF Figure 8	3.0 to 3.6		8	11	ns
t <sub>PD</sub>	Propagation Delay <sup>(6)</sup>	R <sub>L</sub> =50Ω, C <sub>L</sub> =10pF Figure 6, Figure 7	3.3		0.25		ns
O <sub>IRR</sub>	Off Isolation, Non-Adjacent	f=250MHz, R <sub>T</sub> =50Ω Figure 14	3.0 to 3.6		-30	6	dB
Xtalk	Non-Adjacent Channel Crosstalk	f=250MHz, R⊤=50Ω Figure 9	3.0 to 3.6		-43	V	dB
BW	-3db Bandwidth	R <sub>T</sub> =50Ω Figure 13	3.0 to 3.6		720		MHz

Note:

6. Guaranteed by characterization.

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#### **USB Hi-Speed-Related AC Electrical Characteristics**

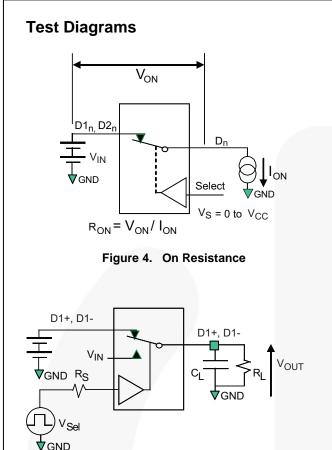
Symbol	Parameter	Conditions		T <sub>A</sub> =- 40°C to +85°C			Units
Symbol	Faiametei	Conditions	V <sub>cc</sub> (V)	Min.	Тур.	Max.	Units
$t_{SK(O)}$	Channel-to-Channel Skew <sup>(7)</sup>	$R_L=50\Omega$ , $C_L=10pF$ Figure 6, Figure 12	3.0 to 3.6		40		ps
t <sub>SK(P)</sub>	Skew of Opposite Transitions of the Same Output <sup>(7)</sup>	$R_L=50\Omega$ , $C_L=10pF$ Figure 6, Figure 12	3.0 to 3.6		20		ps
tJ	Total Jitter <sup>(7)</sup>	$R_L=50\Omega, C_L=10pf, t_R=t_F=750ps at 480Mbps (PRBS=215 - 1)$	3.0 to 3.6		150		ps

Note:

7. Guaranteed by characterization.

## Capacitance

Symbol	Parameter	Conditions	T <sub>A</sub> =- 40°C to +85°C			Unito
Symbol	Farameter	Conditions	Min.	Тур.	Max.	Units
C <sub>IN</sub>	Control Pin Input Capacitance	V <sub>cc</sub> =0V Figure 11		2		pF
C <sub>ON</sub>	D1n, D2n, Dn On Capacitance	V <sub>CC</sub> =3.3V, /OE=0V Figure 10		9		pF
$C_{OFF}$	D1 <sub>n</sub> , D2 <sub>n</sub> Off Capacitance	V <sub>cc</sub> and /OE=3.3V Figure 11		4		pF



 $R_L$ ,  $R_S$ , and  $C_L$  are functions of the application environment (see AC Tables for specific values)  $C_I$  includes test fixture and stray capacitance.



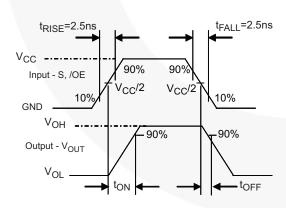
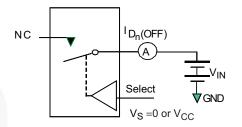
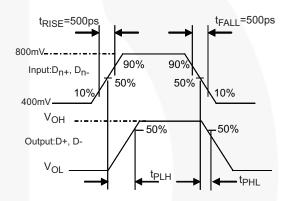


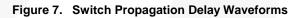
Figure 8. Turn On / Turn Off Waveform



\*\*Each switch port is tested separately

Figure 5. Off Leakage





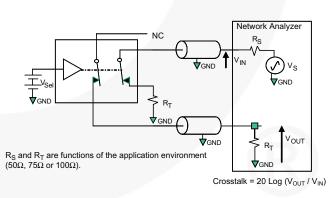
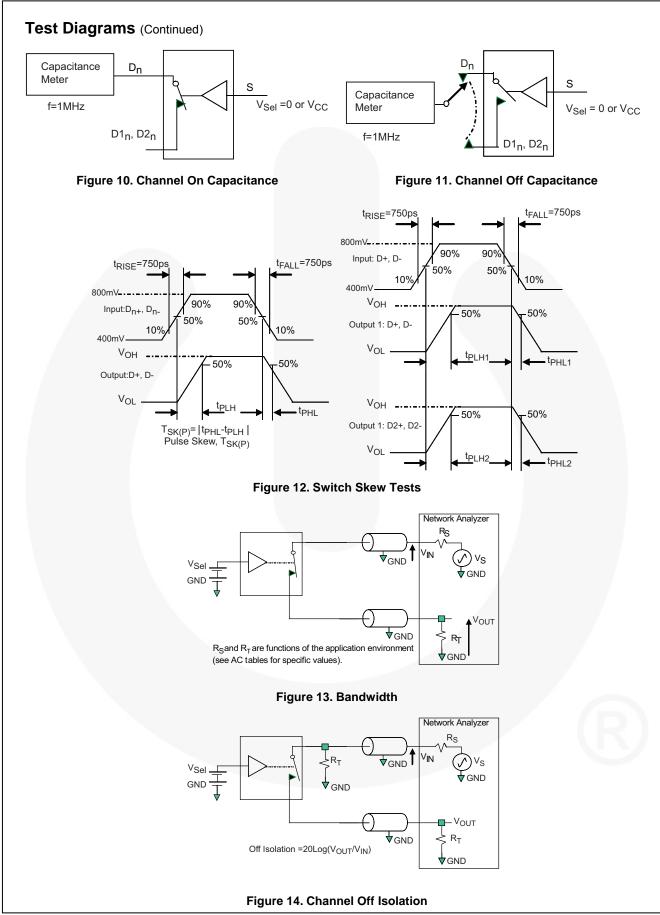
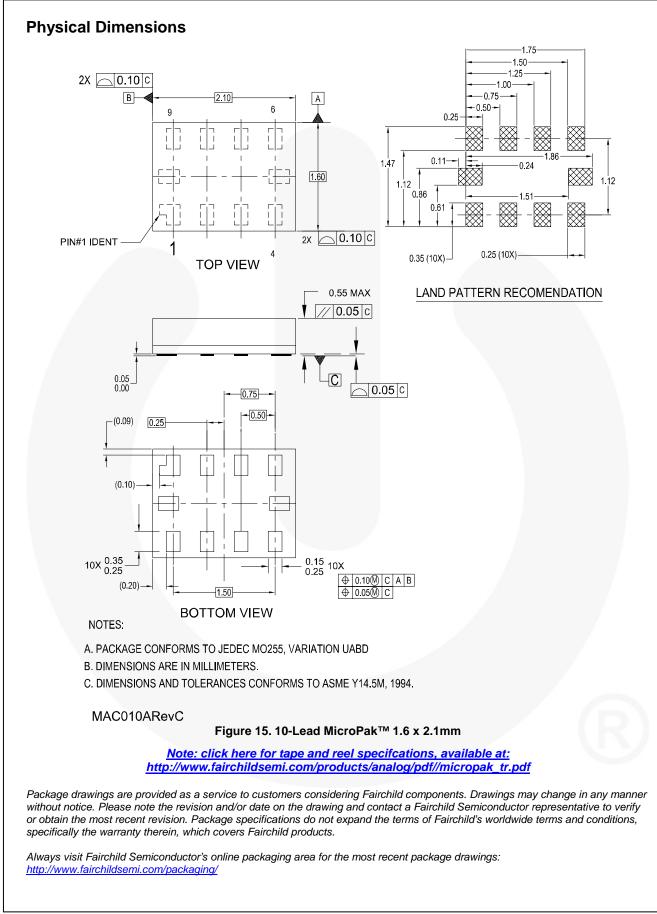
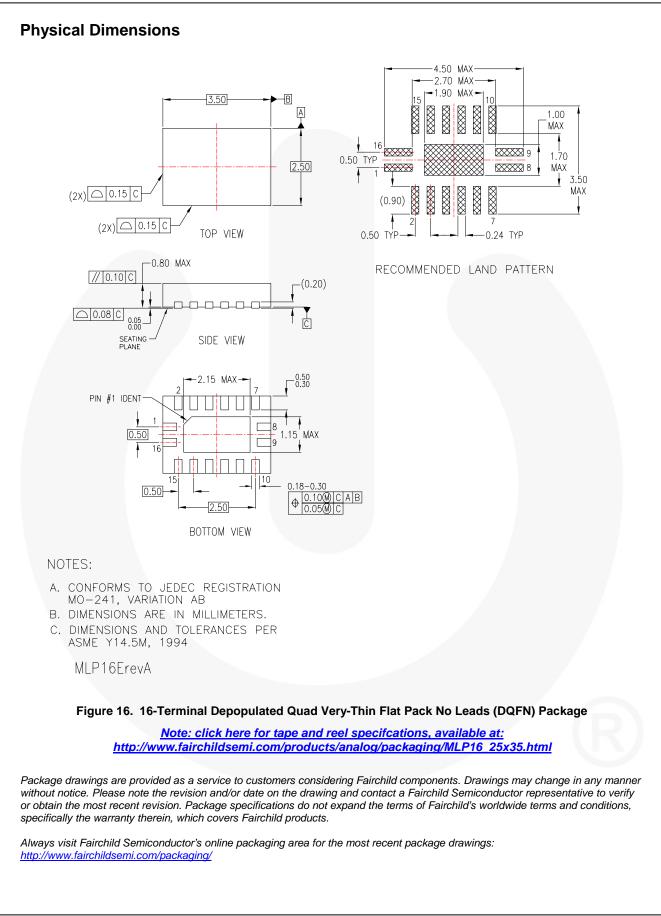


Figure 9. Non-Adjacent Channel-to-Channel Crosstalk







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